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# HMC349LP4C / 349LP4CE



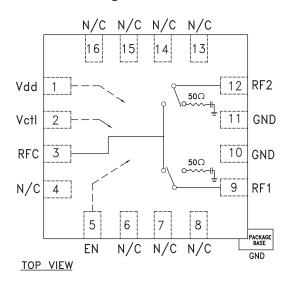
## HIGH ISOLATION SPDT NON-REFLECTIVE SWITCH, DC - 4 GHz

## Typical Applications

The HMC349LP4C / HMC349LP4CE is ideal for:

- · Basestation Infrastructure
- MMDS & 3.5 GHz WLL
- CATV/CMTS
- Test Instrumentation

## **Functional Diagram**



#### **Features**

High Isolation: 67 dB @ 1 GHz

62 dB @ 2 GHz

Single Positive Control: 0/+5V

+52 dBm Input IP3

Non-Reflective Design

All Off State

16 mm<sup>2</sup> Leadless QFN SMT Package

## **General Description**

The HMC349LP4C & HMC349LP4CE are high isolation non-reflective DC to 4 GHz GaAs MESFET SPDT switches in low cost leadless surface mount packages. The switch is ideal for cellular/PCS/3G basestation applications yielding 60 to 65 dB iso-lation, low 0.9 dB insertion loss and +52 dBm input IP3. Power handling is excellent up through the 3.5 GHz WLL band with the switch offering a P1dB compression point of +31 dBm. On-chip circuitry allows a single positive voltage control of 0/+5 Volts at very low DC currents. An enable input (EN) set to logic high will put the switch in an "all off" state.

## Electrical Specifications, $T_A = +25^{\circ}$ C, Vctl = 0/+5 Vdc, Vdd = +5 Vdc, 50 Ohm System

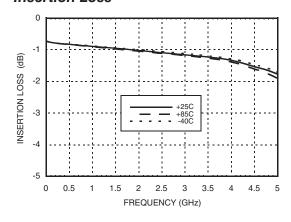
| Parameter   | Frequency   | Min.     | Тур.                     | Max.                     | Units                    |
|---|---|----------|--------------------------|--------------------------|--------------------------|
| Insertion Loss  | DC - 1.0 GHz<br>DC - 2.0 GHz<br>DC - 3.0 GHz<br>DC - 4.0 GHz      |          | 0.9<br>1.0<br>1.2<br>1.4 | 1.2<br>1.3<br>1.5<br>1.7 | dB<br>dB<br>dB<br>dB     |
| Isolation (RFC to RF1/RF2)  | DC - 1.0 GHz<br>DC - 4.0 GHz                                      | 60<br>55 | 67<br>62                 |                          | dB<br>dB                 |
| Return Loss (On State)  | DC - 2.0 GHz<br>DC - 3.0 GHz<br>DC - 4.0 GHz                      |          | 20<br>15<br>13           |                          | dB<br>dB<br>dB           |
| Return Loss (Off State)   | 0.5 - 4.0 GHz   |          | 15                       |                          | dB                       |
| Input Power for 1 dB Compression                                      | 0.25 - 4.0 GHz  | 27       | 31                       |                          | dBm                      |
| Input Third Order Intercept (Two-Tone Input Power = +7 dBm Each Tone) | 0.25 - 1.0 GHz<br>1.0 - 2.0 GHz<br>2.0 - 3.0 GHz<br>3.0 - 4.0 GHz |          | 52<br>50<br>49<br>46     |                          | dBm<br>dBm<br>dBm<br>dBm |
| Switching Speed   | DC - 4.0 GHz  |          |                          |                          |                          |
| tRISE, tFALL (10/90% RF)<br>tON, tOFF (50% CTL to 10/90% RF)          |   |          | 50<br>120                |                          | ns<br>ns                 |



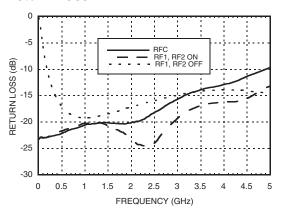


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#### Insertion Loss

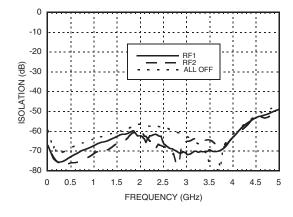


#### **Return Loss**

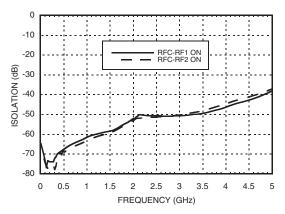


Note: RFC is reflective in "all off" state.

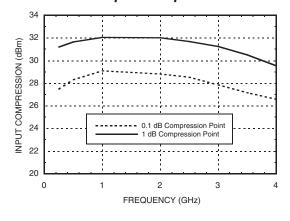
# Isolation Between Ports RFC and RF1 / RF2



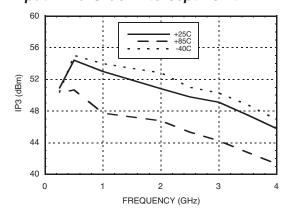
#### Isolation Between Ports RF1 and RF2



#### 0.1 and 1 dB Input Compression Point



## Input Third Order Intercept Point





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# Absolute Maximum Ratings

| RF Input Power (VctI = 0V/+5V) (0.25 - 4 GHz)                 | +30 dBm (T = +85 °C) |  |
|---|----------------------|--|
| Supply Voltage Range (Vdd)                                    | +7 Vdc               |  |
| Control Voltage Range (Vctl)                                  | -1V to Vdd +1V       |  |
| Hot Switch Power Level (Vdd = +5V)                            | +30 dBm              |  |
| Channel Temperature   | 150 °C               |  |
| Continuous Pdiss (T = 85 °C)<br>(derate 12 mW/°C above 85 °C) | 0.75 W               |  |
| Thermal Resistance  | 87 °C/W              |  |
| Storage Temperature   | -65 to +150 °C       |  |
| Operating Temperature   | -40 to +85 °C        |  |
| ESD Sensitivity (HBM)   | Class 1A             |  |

Note: DC blocking capacitors are required at ports RFC, RF1 and RF2. Their value will determine the lowest transmission frequency.



### Bias Voltage & Current

| Vdd Range = +5.0 Vdc ± 10%  |     |     |  |
|---|-----|-----|--|
| Vdd         Idd (Typ.)         Idd (Max.)           (Vdc)         (mA)         (mA) |     |     |  |
| +5.0  | 2.3 | 5.0 |  |

## TTL/CMOS Control Voltages

| State | Bias Condition                   |  |  |
|-------|----------------------------------|--|--|
| Low   | 0 to +0.8 Vdc @ <1 μA Typical    |  |  |
| High  | +2.0 to +5.0 Vdc @ 30 μA Typical |  |  |

#### **Truth Table**

| Control Input |      | Signal Path State |           |  |
|---------------|------|-------------------|-----------|--|
| VctI          | EN   | RFC - RF1         | RFC - RF2 |  |
| Low           | Low  | OFF               | ON        |  |
| High          | Low  | ON                | OFF       |  |
| Low           | High | OFF               | OFF       |  |
| High          | High | OFF               | OFF       |  |

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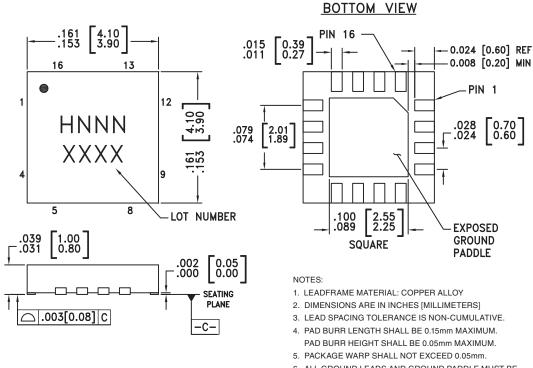
SWIT





## HIGH ISOLATION SPDT NON-REFLECTIVE SWITCH, DC - 4 GHz

## **Outline Drawing**



- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

## Package Information

| Part Number | Package Body Material                              | Lead Finish   | MSL Rating | Package Marking [3] |
|-------------|--|---------------|------------|---------------------|
| HMC349LP4C  | Low Stress Injection Molded Plastic                | Sn/Pb Solder  | MSL1 [1]   | H349<br>XXXX        |
| HMC349LP4CE | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 [2]   | H349<br>XXXX        |

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260  $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX



# HIGH ISOLATION SPDT NON-REFLECTIVE SWITCH, DC - 4 GHz



## **Pin Descriptions**

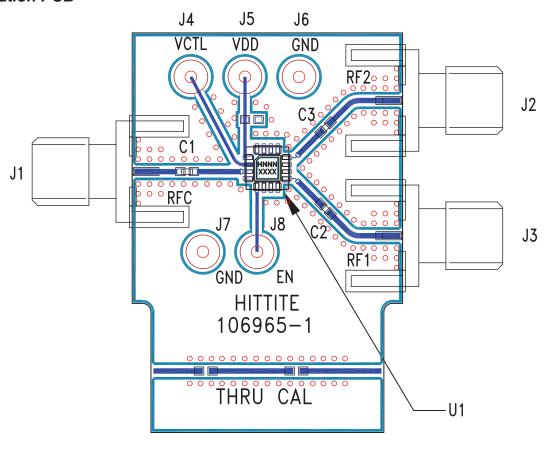
| Pin Number                    | Function      | Description  | Interface Schematic |
|-------------------------------|---------------|--|---------------------|
| 1                             | Vdd           | Supply Voltage.  |                     |
| 2                             | Vctl          | Control input. See truth and control voltage tables.                                       | Vctl 134K           |
| 3, 9, 12                      | RFC, RF1, RF2 | These pins are DC coupled and matched to 50 Ohms. Blocking capacitors are required.        |                     |
| 4, 6, 7, 8,<br>13, 14, 15, 16 | N/C           | No connection. These pins may be connected to RF ground. Performance will not be affected. |                     |
| 5                             | EN            | Enable. See truth and control voltage tables.  | Vctl 134K           |
| 10, 11                        | GND           | Package bottom must also be connected to PCB RF ground.                                    | GND<br>=            |





## HIGH ISOLATION SPDT NON-REFLECTIVE SWITCH, DC - 4 GHz

#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 106975 [1]

| Item    | Description                             |
|---------|---|
| J1 - J3 | PC Mount SMA RF Connector               |
| J4 - J8 | DC Pin                                  |
| C1 - C3 | 100 pF Capacitor, 0402 Pkg.             |
| U1      | HMC349LP4C / HMC349LP4CE<br>SPDT Switch |
| PCB [2] | 106965 Evaluation PCB                   |

<sup>[1]</sup> Reference this number when ordering complete evaluation PCB

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and backside ground slug should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.

<sup>[2]</sup> Circuit Board Material: Rogers 4350